

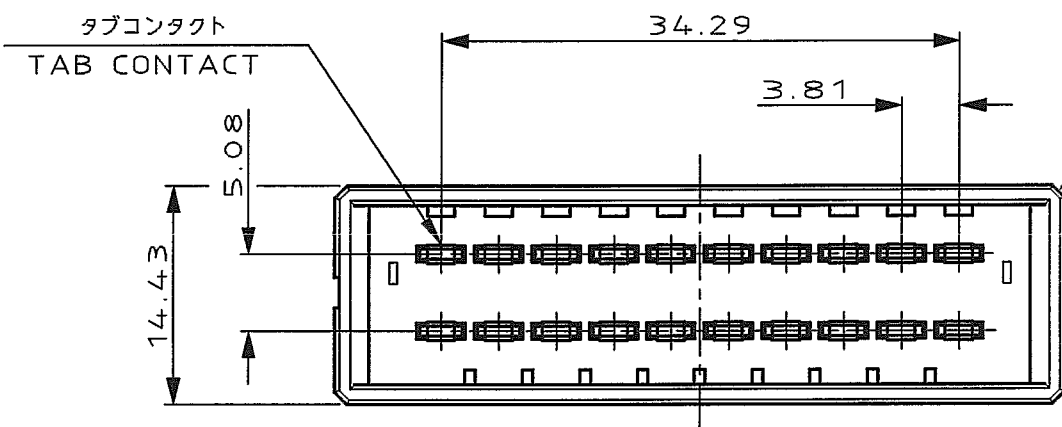
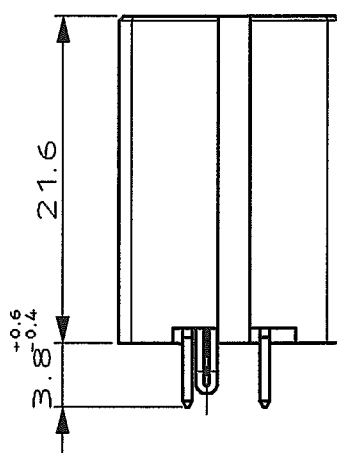
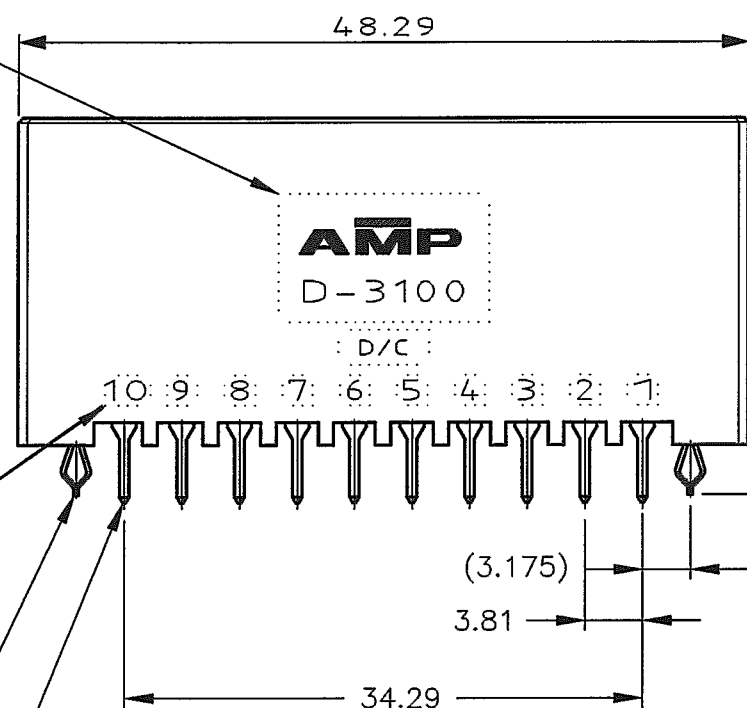
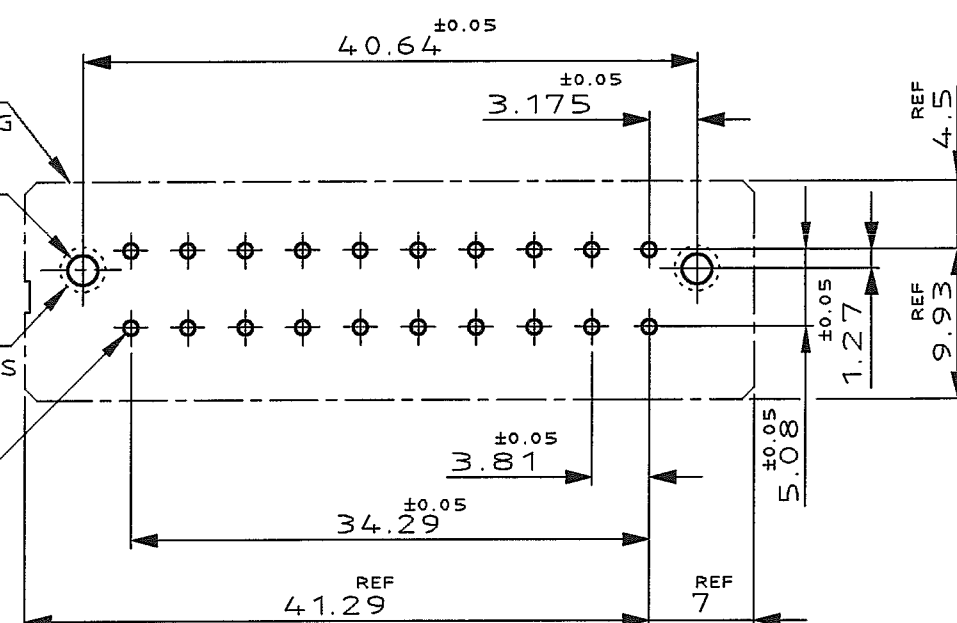
NUMBER 178328



METRIC

DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT

PRINT DIST

AMPマーク
シリーズマーク
SERIES MARK回路番号
CIRCUIT NO
リテンションレグ
RETENTION LEG
コンタクト半田付部
CONTACT TAILコネクタ外形
OUTLINE OF HEADER HOUSING
スルーホール 2-φ2
DIA2±0.1 2PLACES
ラウンド 2-φ3MIN
ROUND DIA3MIN 2PLACES
20-φ1.1
DIA 1.1±0.1 20PLACES

推奨基板取付け寸法

PC 基板厚:1.6±0.1
(非累積公差)
(コネクタ搭載面)

RECOMEND PC BOARD HOLE PATTERN

PC BOARD THICKNESS:1.6±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)

NOTES

- MATERIAL:HOUSING:GLASS FILED THERMO
PLASTIC,POLYESTER COLOR:BLACK
CONTACT:COPPER ALLOY
RETENTION LEG:COPPER ALLOY
- FINISH(CONTACT AREA):0.38μm PdNi & Au PLATING OVER NICKEL
- FINISH(CONTACT AREA):0.76μm PdNi & Au PLATING OVER NICKEL
- FINISH(CONTACT AREA):2.0 μmMIN TIN
PLATED OVER NICKEL
- ~~FINISH(RETENTION LEG):TIN LEAD PLATED
(CONTACT TAIL) OVER NICKEL~~
- FINISH(RETENTION LEG):TIN PLATED
(CONTACT TAIL) OVER NICKEL

△6	△4	178328-5
△6	△3	178328-3
△6	△2	178328-2
(FINISH)		製品番号 (PART NO.)

E	REVISED PER ECR-25-250788	F.Z	R.B	16JAN 2025
D1	REVISED PER ECO-11-005030	RK	HMR	23MAR11
LTR	REVISION RECORD	DR	CHK	DATE

WIRE RANGE		INSULATION DIA	NAME	20POS DOUBLE ROW VERTICAL HDR ASS'Y FOR DYNAMIC D-3100		
mm²(AWG -)		mmφ		一般公差 (GENERAL TOLERANCE)	SIZE	LOC
MATERIAL SEE NOTE 注記参照		FINISH SEE NOTE 注記参照		10mm以下 : ±0.3 10mm以上 30mm以下 : ±0.4 30mm以上 100mm以下 : ±0.5 角度 : ±3°	A3	J
DR. 20-JAN-'93 Y.TANAKA	DE. 20-JAN-'93 Y.TANAKA	CHK. 8-FEB-'93 S.MANABE	APP. 8-FEB-'93 S.MANABE	SCALE 2-1	REV. E	SHEET 1 OF 1

TE Connectivity

C-178328